

SUBMINIATURE SOLID STATE LAMP

Part Number: AM2520SGD03

Super Bright Green

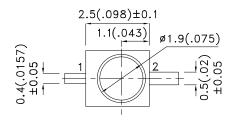
Features

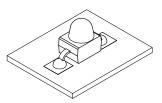
- Subminiature package.
- Gull wing lead.
- Long life solid state reliability.
- Low package profile.
- Moisture sensitivity level : level 3.
- Package: 1000pcs / reel.
- RoHS compliant.

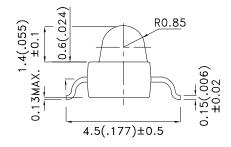
Description

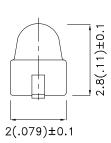
The Super Bright Green source color devices are made with Gallium Phosphide Green Light Emitting Diode.

Package Dimensions









-13-

Notes:

- 1. All dimensions are in millimeters (inches).
 2. Tolerance is ±0.25(0.01") unless otherwise noted.
- 3. Lead spacing is measured where the leads emerge from the package.
- 4. Specifications are subject to change without notice.
- 5. The device has a single mounting surface. The device must be mounted according to the specifications.





SPEC NO: DSAD1260 **REV NO: V.4 DATE: JUN/30/2009**

PAGE: 1 OF 5 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: D.M.Su ERP: 1202000642

Selection Guide

Part No.	Dice	Lens Type	Iv (mcd) [2] @ 20mA		Viewing Angle [1]
		2.	Min.	Тур.	201/2
AM2520SGD03	Super Bright Green (GaP)	GREEN DIFFUSED	2.6	10	40°

Notes:

- 1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value. 2. Luminous intensity/ luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Super Bright Green	565		nm	IF=20mA
λD [1]	Dominant Wavelength	Super Bright Green	568		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Super Bright Green	30		nm	IF=20mA
С	Capacitance	Super Bright Green	15		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Super Bright Green	2.2	2.5	V	IF=20mA
lR	Reverse Current	Super Bright Green		10	uA	V _R =5V

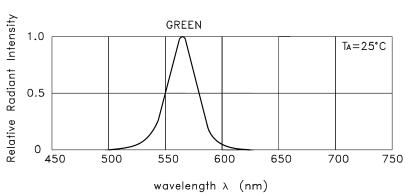
- Notes: 1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

Absolute Maximum Ratings at TA=25°C

Parameter	Super Bright Green	Units	
Power dissipation	62.5	mW	
DC Forward Current	25	mA	
Peak Forward Current [1]	140	mA	
Reverse Voltage	5	V	
Operating Temperature	-40°C To +85°C		
Storage Temperature	-40°C To +85°C		

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

SPEC NO: DSAD1260 **REV NO: V.4** DATE: JUN/30/2009 PAGE: 2 OF 5 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: D.M.Su ERP: 1202000642

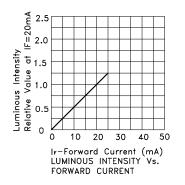


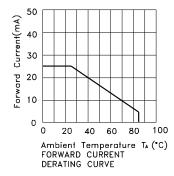
RELATIVE INTENSITY Vs. WAVELENGTH

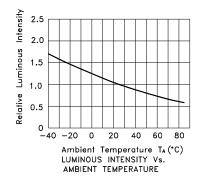
Super Bright Green

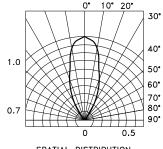
50 E 40 te 30 D 20 0 1.5 1.7 1.9 2.1 2.3 2.5 Forward Voltage(V) FORWARD CURRENT Vs. FORWARD VOLTAGE

AM2520SGD03









SPATIAL DISTRIBUTION

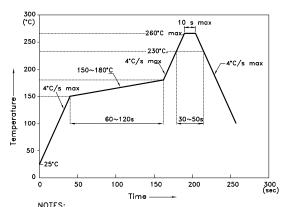
 SPEC NO: DSAD1260
 REV NO: V.4
 DATE: JUN/30/2009
 PAGE: 3 OF 5

 APPROVED: WYNEC
 CHECKED: Allen Liu
 DRAWN: D.M.Su
 ERP: 1202000642

AM2520SGD03

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



NOTES:

1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

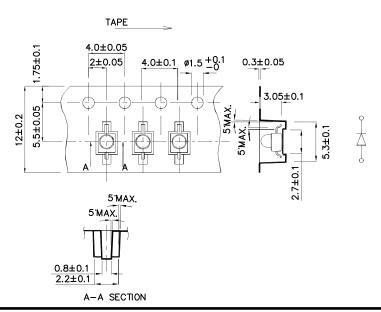
2.Don't cause stress to the epoxy resin while it is exposed to high temperature. to high temperature.

3.Number of reflow process shall be 2 times or less.

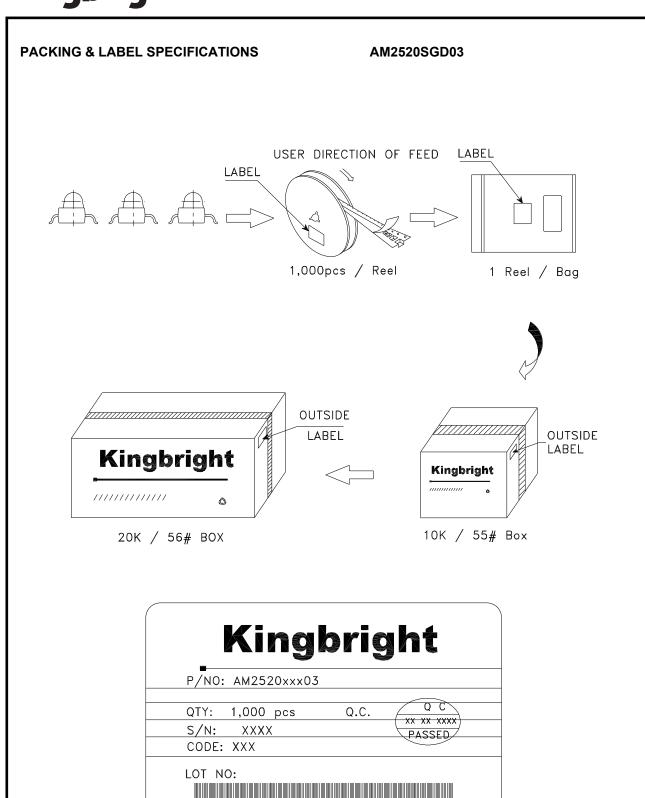
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



Tape Dimensions (Units: mm)



SPEC NO: DSAD1260 **REV NO: V.4 DATE: JUN/30/2009** PAGE: 4 OF 5 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: D.M.Su ERP: 1202000642



SPEC NO: DSAD1260 APPROVED: WYNEC REV NO: V.4 CHECKED: Allen Liu DATE: JUN/30/2009 DRAWN: D.M.Su

RoHS Compliant

PAGE: 5 OF 5 ERP: 1202000642